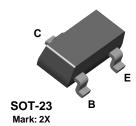


2N4401

MMBT4401





NPN General Pupose Amplifier

This device is designed for use as a medium power amplifier and switch requiring collector currents up to 500 mA.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	40	V
V _{CBO}	Collector-Base Voltage	60	V
V _{EBO}	Emitter-Base Voltage	6.0	V
I _C	Collector Current - Continuous	600	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- These ratings are based on a maximum junction temperature of 150 degrees C.
 These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max		Units
		2N4401	*MMBT4401	
P_{D}	Total Device Dissipation	625	350	mW
	Derate above 25°C	5.0	2.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

^{*}Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

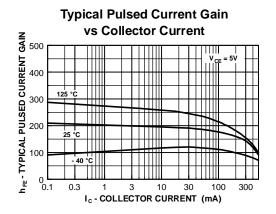
NPN General Purpose Amplifier (continued)

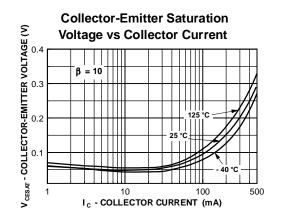
Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHA	RACTERISTICS				
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage*	$I_C = 1.0 \text{ mA}, I_B = 0$	40		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_{\rm C} = 0.1 \text{mA}, I_{\rm E} = 0$	60		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 0.1 \text{ mA}, I_C = 0$	6.0		V
I _{BL}	Base Cutoff Current	$V_{CE} = 35 \text{ V}, V_{EB} = 0.4 \text{ V}$		0.1	μΑ
I _{CEX}	Collector Cutoff Current	$V_{CE} = 35 \text{ V}, V_{EB} = 0.4 \text{ V}$		0.1	μА
ON CHAR	ACTERISTICS*				
h _{FE}	DC Current Gain	$I_C = 0.1 \text{ mA}, V_{CE} = 1.0 \text{ V}$	20		
		$I_C = 1.0 \text{ mA}, V_{CE} = 1.0 \text{ V}$	40		
		$I_C = 10 \text{ mA}, V_{CE} = 1.0 \text{ V}$	80		
		$I_C = 150 \text{ mA}, V_{CE} = 1.0 \text{ V}$	100	300	
.,	Oallantas Fasition Oatomatics Maltana	$I_C = 500 \text{ mA}, V_{CE} = 2.0 \text{ V}$	40	0.4	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$		0.4 0.75	V
1/		$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$		0.73	V
\/	Rase-Emitter Saturation Voltage		0.75	0.95	V
V _{BE(sat)}	Base-Emitter Saturation Voltage	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$ $I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$	0.75	0.95 1.2	V V V
SMALL S	Base-Emitter Saturation Voltage GNAL CHARACTERISTICS Current Gain - Bandwidth Product	I_{C} = 150 mA, I_{B} = 15 mA I_{C} = 500 mA, I_{B} = 50 mA	250		
SMALL S	IGNAL CHARACTERISTICS	$\begin{split} I_{C} &= 150 \text{ mA}, \ I_{B} = 15 \text{ mA} \\ I_{C} &= 500 \text{ mA}, \ I_{B} = 50 \text{ mA} \end{split}$ $\begin{split} I_{C} &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ V_{CB} &= 5.0 \text{ V}, \ I_{E} = 0, \end{split}$			V
SMALL SI	IGNAL CHARACTERISTICS Current Gain - Bandwidth Product	$\begin{split} I_C &= 150 \text{ mA}, \ I_B = 15 \text{ mA} \\ I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \end{split}$ $\begin{split} I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ V_{CB} &= 5.0 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \end{split}$		1.2	V MHz
$V_{BE(Sat)}$ $\begin{array}{c} SMALL \ SI \\ f_T \\ C_{Cb} \\ C_{eb} \\ h_{ie} \end{array}$	GNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance	$\begin{split} I_{C} &= 150 \text{ mA}, \ I_{B} = 15 \text{ mA} \\ I_{C} &= 500 \text{ mA}, \ I_{B} = 50 \text{ mA} \end{split}$ $\begin{split} I_{C} &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ V_{CB} &= 5.0 \text{ V}, \ I_{E} = 0, \\ f &= 140 \text{ kHz} \end{split}$		6.5	V MHz pF
SMALL SI f _T C _{cb}	GNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance	$\begin{split} I_C &= 150 \text{ mA}, \ I_B = 15 \text{ mA} \\ I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \end{split}$ $\begin{split} I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \end{split}$ $\begin{split} V_{CB} &= 5.0 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \end{split}$ $V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \end{split}$ $I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \end{split}$	250	6.5	V MHz pF pF kΩ
SMALL SI f _T C _{cb} C _{eb} h _{ie}	GNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance Input Impedance	$\begin{split} I_C &= 150 \text{ mA}, \ I_B = 15 \text{ mA} \\ I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \end{split}$ $\begin{split} I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ V_{CB} &= 5.0 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $\begin{aligned} I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{aligned}$ $\begin{aligned} I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{aligned}$ $\begin{aligned} I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{aligned}$	250	6.5 30 15	V MHz pF pF kΩ
SMALL SI f _T C _{cb} C _{eb}	IGNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance Input Impedance Voltage Feedback Ratio	$\begin{split} I_C &= 150 \text{ mA}, \ I_B = 15 \text{ mA} \\ I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \end{split}$ $\begin{split} I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ V_{CB} &= 5.0 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $I_C = 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$	250 1.0 0.1	6.5 30 15 8.0	MHz pF
SMALL SI f _T C _{cb} C _{eb} h _{ie} h _{fe} h _{fe} h _{oe}	IGNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance Input Impedance Voltage Feedback Ratio Small-Signal Current Gain	$\begin{split} I_C &= 150 \text{ mA}, \ I_B = 15 \text{ mA} \\ I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \end{split}$ $\begin{split} I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ V_{CB} &= 5.0 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{bmatrix}$	250 1.0 0.1 40	6.5 30 15 8.0 500	V MHz pF pF kΩ x 10 ⁻⁴
SMALL SI C _{cb} C _{eb} h _{ie} h _{re} SWITCHII	GNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance Input Impedance Voltage Feedback Ratio Small-Signal Current Gain Output Admittance	$\begin{split} I_C &= 150 \text{ mA}, \ I_B = 15 \text{ mA} \\ I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \end{split}$ $\begin{split} I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ V_{CB} &= 5.0 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{bmatrix}$	250 1.0 0.1 40	6.5 30 15 8.0 500	V MHz pF pF kΩ x 10 ⁻⁴
SMALL SI f _T C _{cb} C _{eb} h _{ie} h _{re} h _{oe} SWITCHII	IGNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance Input Impedance Voltage Feedback Ratio Small-Signal Current Gain Output Admittance	$\begin{split} I_C &= 150 \text{ mA}, \ I_B = 15 \text{ mA} \\ I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \end{split}$ $\begin{split} I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ V_{CB} &= 5.0 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $V_{CC} &= 30 \text{ V}, \ V_{EB} = 2 \text{ V}, \\ \end{split}$	250 1.0 0.1 40	1.2 6.5 30 15 8.0 500	V MHz pF pF kΩ x 10 ⁻⁴
SMALL SI f _T C _{cb} C _{eb} h _{ie} h _{fe} h _{fe}	IGNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance Input Impedance Voltage Feedback Ratio Small-Signal Current Gain Output Admittance NG CHARACTERISTICS Delay Time	$\begin{split} I_C &= 150 \text{ mA}, \ I_B = 15 \text{ mA} \\ I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \end{split}$ $\begin{split} I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ \end{split}$ $\begin{split} V_{CB} &= 5.0 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $\begin{split} V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \end{split}$ $\begin{split} I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $\begin{split} I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $\begin{split} I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $\begin{split} I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$ $\begin{split} I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$	250 1.0 0.1 40	1.2 6.5 30 15 8.0 500 30	V MHz pF pF kΩ x 10 ⁻⁴ μmhos

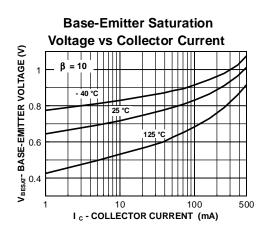
^{*}Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

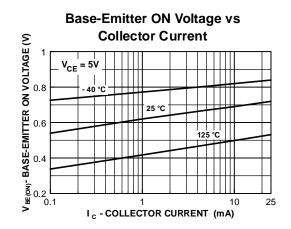
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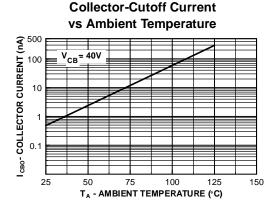
Typical Characteristics

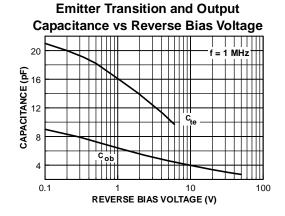








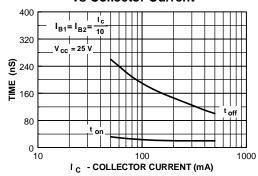




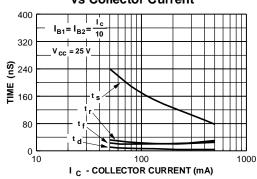
(continued)

Typical Characteristics (continued)

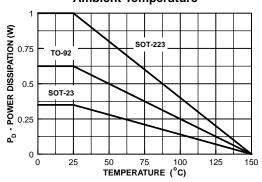
Turn On and Turn Off Times vs Collector Current



Switching Times vs Collector Current

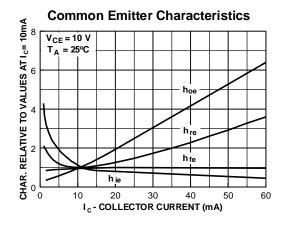


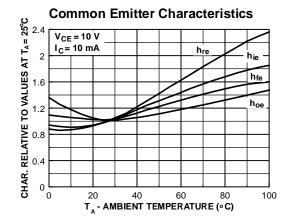
Power Dissipation vs Ambient Temperature

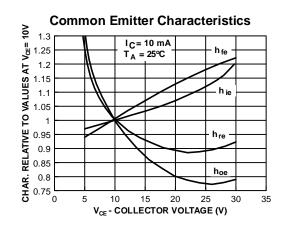


(continued)

Typical Common Emitter Characteristics (f = 1.0kHz)







(continued)

Test Circuits

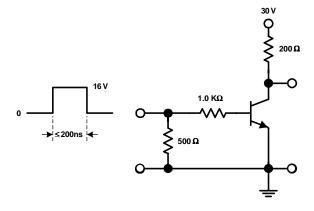


FIGURE 1: Saturated Turn-On Switching Timer

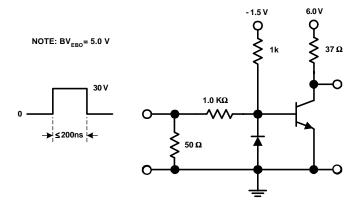


FIGURE 2: Saturated Turn-Off Switching Time

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Datasheet Identification	Product Status	Definition
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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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